

Heat Shrinkable Compound Double Wall Pipe

Product legend

新缆®
XINLAN



Characteristics:

Heat shrinkable compound double wall pipe made of heat shrinkable insulation material and heat shrinkables semiconductive material by the way of special processing technology. Inner layer show good insulation performance, outer layer is of semi-conductive, inner and outer layers are clung closely, shielded reliably.

Application:

It is used for the insulation and outer shield of medium joint in 35kv and below power cable, and others where it needs for the insulation and shield.

Technical Data

Type and specification	Internal diameter before shrinking	Internal diameter after shrinking	Total wall thickness	Length
HDFH 30/11	≥ 30	≤ 1	4.5	300-1200
HDFH 35/13	≥ 35	≤ 13	4.5	300-1200
HDFH 45/16	≥ 45	≤ 16	4.5	300-1200
HDFH 55/20	≥ 55	≤ 20	4.5	300-1200
HDFH 65/25	≥ 65	≤ 25	4.5	300-1200
HDFH 88/30	≥ 85	≤ 30	5	300-1200
HDFH 100/38	≥ 100	≤ 38	5	300-1200
HDFH 120/45	≥ 120	≤ 45	5	300-1200